

Posistor[®] for over current protection PRG SERIES

BC-E0313

PRG21AR4R7MS5RA

For Automotive

1. Part Numbering

ex) PR G 21 AR 4R7 M S5 RA
 Product ID Series Dimensions Temperature Resistance Resistance Individual Packaging
 Characteristics Tolerance Specifications

2. Ratings

Part Number	Resistance (at 25°C)	Max. Voltage	*1 Max. Current	*2 Hold Current	*3 Trip Current
PRG21AR4R7MS5RA	4.7ohm ±20%	DC 16 V	4.26A	---	525mA (at -40°C)
				205mA (at +25°C)	390mA (at +25°C)
				110mA (at +85°C)	---

Packaging Tape : Taping (Standard quantity is 4000pcs. Per reel)

*1: The maximum current value that can be repeatedly flowed when the circuit operates in abnormal condition.

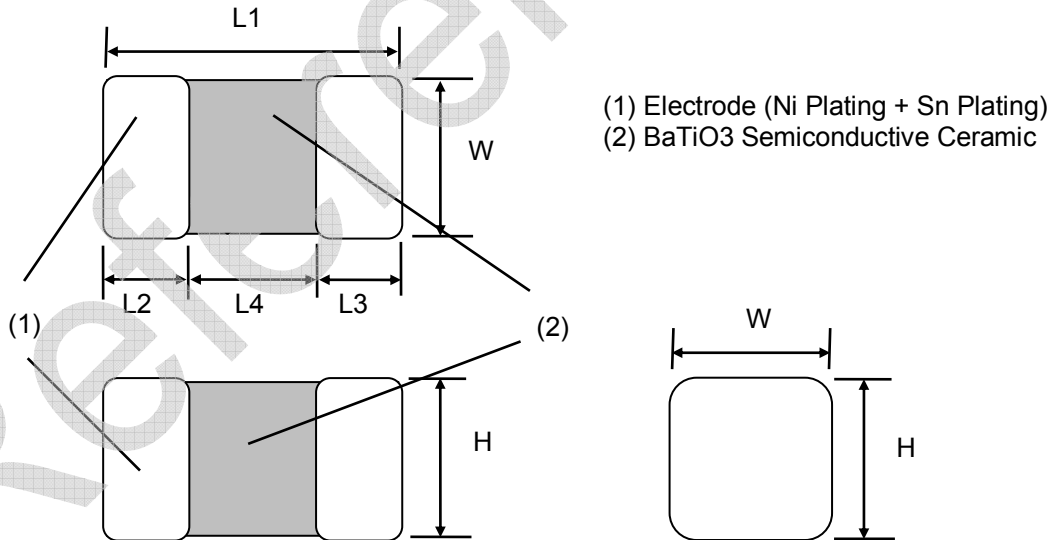
*2: The maximum current value that can be continuously flowed without tripping at +25°C, +85°C

*3: The trip current value that Posistor[®] protects circuit from overload at +25°C and -40°C.

*4: These values are valid in mounted condition which thermal dissipation coefficient is 10mW/°C.

In other conditions, ratings value may be different.

3. Dimensions (mm)

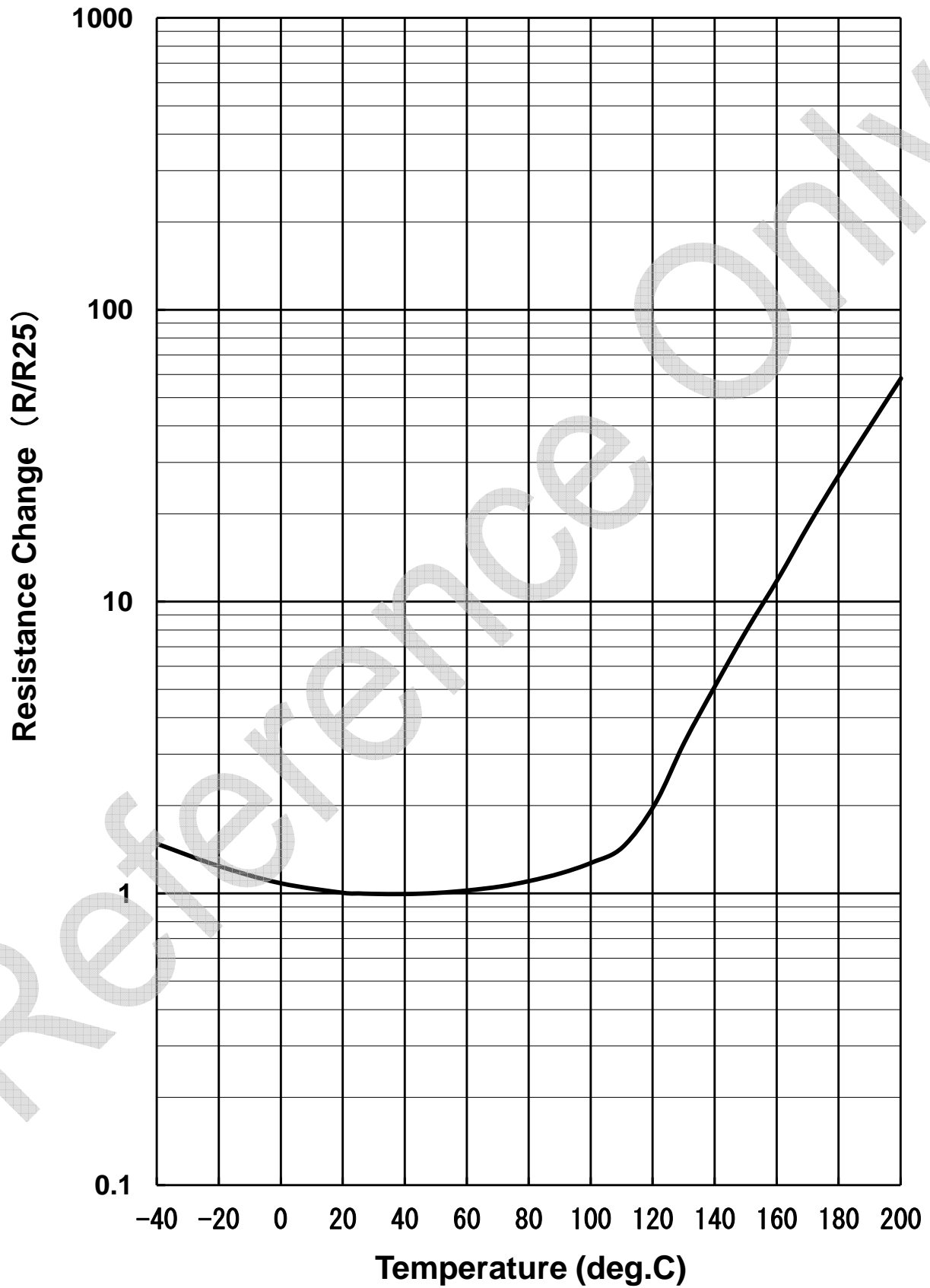


L1	W	H	L2 and L3	L4
2.00±0.20	1.25±0.20	0.90±0.20	Min. 0.2	Min. 0.5

4. Quantity (Standard Quantity)

Products quantity in a reel
4,000 pcs. /reel

Resistance-Temperature Characteristics Typical Curve



Notice for use

⚠ Caution

1. This product is designed for application, which is used under ordinary environment. (room temperature, normal humidity, normal pressure) Do not expose this to the following environments, because all these factors can deteriorate the characteristic of this and can cause failure or burn out.

- (1) Corrosive gas or deoxidizing gases (Cl₂, H₂S, NH₃, SO_x, NO_x etc.)
- (2) Volatile, flammable gas
- (3) Dusty place
- (4) Place in a vacuum, reducing or putting pressure
- (5) Place in splashed water, or high humidity and dewing place
- (6) Salt water, oil, chemical liquid and solvent
- (7) Vibratile place
- (8) Other place equivalent to the above

2. Limitation of Applications

Please contact us before using our products for the under-mentioned applications requiring especially high reliability in order to prevent defects which might directly cause damage to other party's life body or property (listed below).

- (1) Aircraft equipment (2) Aerospace equipment (3) Undersea equipment
- (4) Power plant control equipment (5) Medical equipment
- (6) Transportation equipment (automobiles, trains, ships, etc.) (7) Traffic signal equipment
- (8) Disaster prevention / Crime prevention equipment (9) Data-processing equipment
- (10) Applications of similar complexity or with reliability requirements comparable to the applications listed in the above

3. Be sure to provide an appropriate fail-safe function on your product to prevent a second damage that may be caused by the abnormal function or the failure of our product.

Notice

1. Do not apply abnormal voltage/current exceeding the specified maximum value. Because they may deteriorate or destroy PTC element.

2. Use this product within the specified temperature. A higher temperature may deteriorate the characteristic or material.

3. The body of this product is not insulated. Please keep an adequate distance to surrounding components and wiring.

4. Storage conditions

To keep solderability from declining, following storage condition is recommended.

- (1) Condition Temperature : -10 to +40°C
 Humidity : Less than 75%RH (not dewing condition)
- (2) Term: Please use this POSISTOR within 6 months after shipment by first-in and first-out stocking system.
- (3) Handling after seal open: After unpacking of the minimum package, reseal it promptly or store it inside a sealed container with a drying agent.
- (4) Place: Do not store this product in corrosive gas (SO_x, Cl etc) or under sunlight.

5. Solder and Flux

(1) Solder Paste

Use solder paste with Sn:Pb=60:40wt% , Sn:Pb=63:37wt% , Sn:Ag:Cu=96.5:3.0:0.5wt%

Use of the solder containing Zn may reduce adhesive strength. When you use the solder containing Zn, please contact us in advance.

For your reference, we are using

'63Sn/37Pb RMA9086 90-3-M18', manufactured by Alpha Metals Japan Ltd.,

'96.5Sn/3.0Ag/0.5Cu M705-GRN360-K2-V', manufactured by Senju Metal Industry Co., LTD for any Internal tests of this product.

(2) Flux

Use rosin type flux in soldering process.

If below flux is used, some problems might be caused in the product characteristics and reliability. Please do not use below flux.

- Strong acidic flux (with halide content exceeding 0.2wt%).
- Water-soluble flux(*Water-soluble flux can be defined as non rosin type flux including wash-type flux and non-wash-type flux.)

6. For removing the flux after soldering, observe the following points in order to avoid deterioration of the characteristics or any change of the external electrodes quality.

(1) Cleaning Conditions

Solvent	Dipping Cleaning	Ultrasonic Cleaning
2-propanol	Less than 5 min. at room temp. or Less than 2 min. at 40°C max.	Less than 1 min. 20W/L max. Frequency of several 10 kHz to 100 kHz.

*A sufficient cleaning shall be applied to remove flux

*2-propanol is recommended as cleaning solvent. Please contact us in case you use other cleaning solvent.

(2) Drying : After cleaning, dry promptly this product.

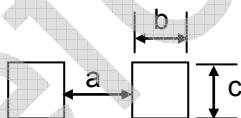
7. In your mounting process, observe the following points in order to avoid deterioration of the characteristics or destruction of this product. The mounting quality of this product may also be affected by the mounting conditions, shown the points below.

This product is for only reflow soldering. Flow soldering shall not be allowed.

Please mount this product by soldering. When mounted by other methods, such as conductive adhesives, please contact us in advance.

(1) Standard Land Size

Too big land size gives too much solder paste on the land. It may cause destruction of this product, because of the mechanical stress especially in the case of board bending.



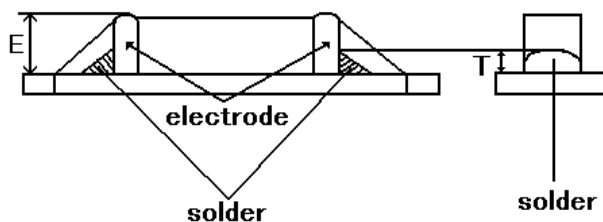
a	b	c
1.0~1.2	0.5~0.7	1.0~1.2

(mm)

(2) Printing Conditions of Solder Paste

i. Standard thickness of solder paste printing shall be from 0.15 to 0.20 mm.

ii. After soldering, the solder fillet shall be a height from 0.2 mm to the thickness of this product. (See the figures below.)

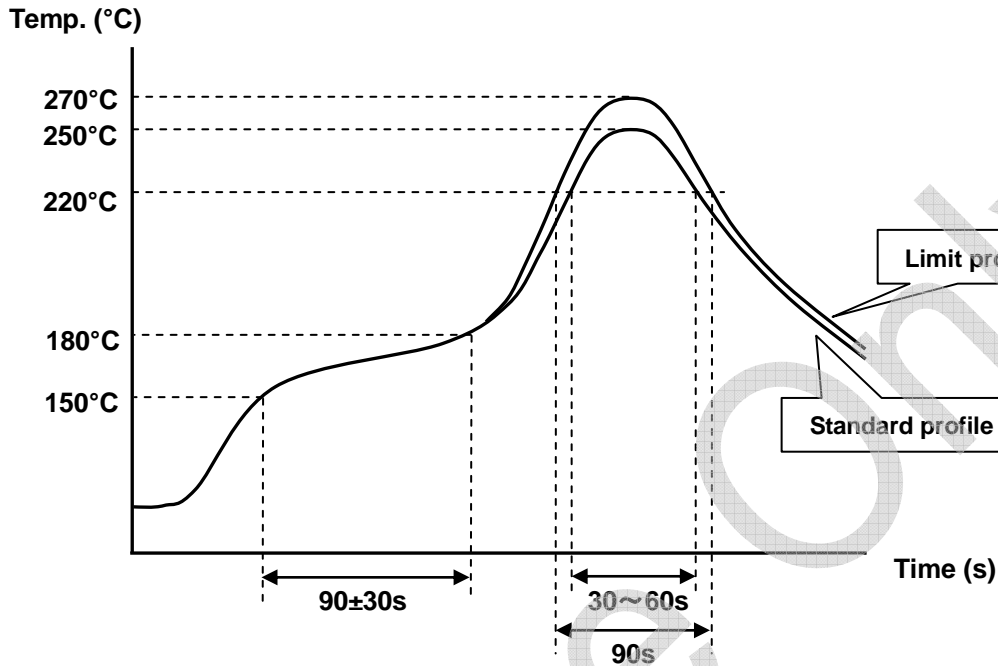


$$0.2\text{mm} \leq T \leq E$$

iii. Too much solder gives too strong mechanical stress to this product, such stress may cause cracking or any mechanical damage. And also, it can destroy the electrical performance of this product.

(3) Reflow soldering conditions

The following figure and table show our recommended reflow profile.



	Standard profile	Limit profile
Preheat	150~180°C, 90±30s	
Soldering time (≥220°C)	30~60s	90s
Peak temp.	250°C	270°C
Reflow cycle	Max. 2times	Max. 2times

- I. Insufficient preheating may cause a crack on ceramic body. The temperature difference between preheat and peak should be control within 100°C to prevent this.
- II. The excessive soldering conditions may cause dissolution of metallization or deterioration of solder-wetting on the external electrode.
- III. Rapid cooling by dipping in solvent or by other means is not recommended.
- IV. Please evaluate it on your condition if you will do mounting using not applying condition to the above-mentioned.

(4) There is a fear of unexpected failures (tombstone, insufficient solder-wetting, etc.) in your mounting process, caused by the mounting conditions. Please evaluate if this product is correctly mounted under your mounting conditions.

(5) Conditions with Soldering Iron

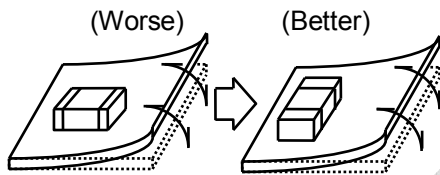
When hand soldering by iron is applied, be sure to keep following conditions.

Item	Conditions
Preheating	at 150°C for 1 to 2 minute
Temperature of Iron-tip	280°C max.
Soldering Iron Wattage	30W max.
Diameter of Iron-tip	3mm dia. max.
Soldering Time	5sec. max.
Solder	H60A (Sn:Pb=60:40wt%) type , H63A (Sn:Pb=63:37wt%) type, Sn:Ag:Cu=96.5:3.0:0.5wt% or equivalent type.
Flux	Do not use strong acidic flux (with halide content exceeding 0.2wt%).
Caution	Do not allow the iron-tip to directly touch the ceramic body. Preheat the ceramic body and mounting board.

8. Do not give this product a strong press-force nor a mechanical shock.
Because such mechanical forces may cause cracking or chipping of this ceramic product.
9. Rapid cooling or heating during soldering is not recommended.
Such treatment may destroy the element.
10. When this product is operated, temperature of some area may be over 100 to 150°C. Be sure that surrounding parts and inserting material can withstand the temperature. If the surrounding part and material is kept under such condition, they may be deteriorated or may produce harmful gases (Cl₂, H₂S, NH₃, SO_x, NO_x etc.). And, such harmful gas may deteriorate the element.
11. Do not assemble this product with air-sealing or resin casting. Such sealing may deteriorate the characteristic or destroy PTC element.
12. Location on Printed Circuit Board(PC Board)

<Component Direction>

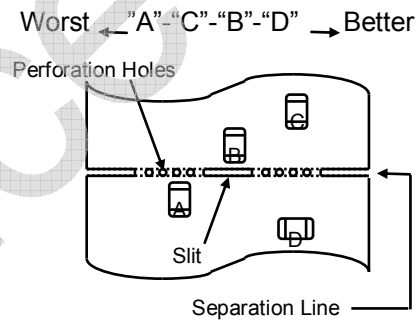
Locate this product horizontal to the direction in which stress acts.



<Mounting Close to Board Separation Line>

Put this product on the PC Board near the Slit, not near the Perforation Holes.

Keep this product on the PC Board away from the Separation Line.



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- Специальные условия для постоянных клиентов.
- Подбор аналогов.
- Поставку компонентов в любых объемах, удовлетворяющих вашим потребностям.
- Приемлемые сроки поставки, возможна ускоренная поставка.
- Доставку товара в любую точку России и стран СНГ.
- Комплексную поставку.
- Работу по проектам и поставку образцов.
- Формирование склада под заказчика.
- Сертификаты соответствия на поставляемую продукцию (по желанию клиента).
- Тестирование поставляемой продукции.
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- Входной контроль качества.
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- Регистрацию проекта у производителя компонентов.
- Техническую поддержку проекта.
- Защиту от снятия компонента с производства.
- Оценку стоимости проекта по компонентам.
- Изготовление тестовой платы монтаж и пусконаладочные работы.



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